

SAC3054BQP3



GaAs MMIC Low Noise Amplifier
0.4~2.1GHz

Rev 1.0

Features

- Frequency: 0.4~2.1GHz
- Gain: 27dB
- Output P_{1dB}: 14dBm
- Single Power Supply: +5V@50mA
- Package Size: 3mmx3mmx0.75mm

Typical Applications

- Microwave Radios
- SATCOM
- Test and Measurement
- Fiber Optics

General Description

SAC3054BQP3 is a GaAs MMIC Low Noise Amplifier die which operates between 0.4~2.1GHz. The amplifier can provide 27dB gain, 14dBm Output P_{1dB}, 1.2dB noise figure from a 50mA supply current.

Electrical Performance (T_A=25°C, V_D=+5V, I_D=50mA, Z₀=50Ω)

Parameter	Min.	Typ.	Max.	Units
Frequency Range	0.4~2.1			GHz
Gain	24.5	27	30.5	dB
Gain Flatness	—	±1	±2	dB
Reverse Isolation	55	60	—	dB
Input/Output VSWR	—	1.3	2	: 1
Noise Figure	—	1.2	1.9	dB
Output P _{1dB}	13	14	—	dBm
Output IP ₃	—	24	—	dBm
Supply Current(I _D)	—	50	—	mA

Absolute Maximum Ratings

Maximum Input Power	+14dBm	Operating Temperature	-40°C~+85°C
Maximum V _D	+5.5V	Storage Temperature	-40°C~+150°C

SuperApex, LLC

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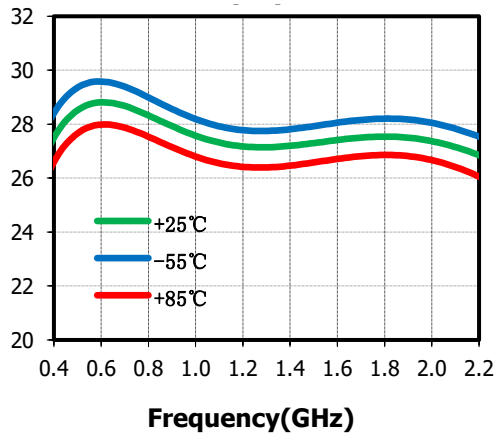


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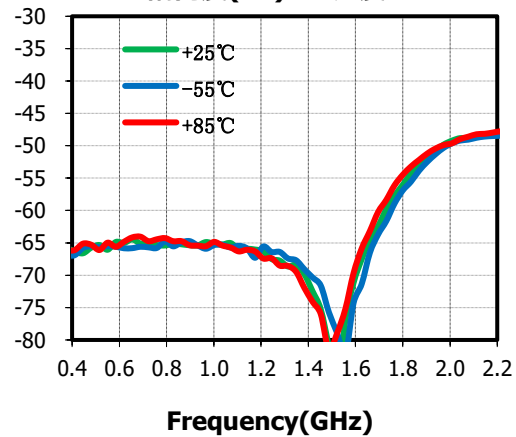
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Typical Performance Curve

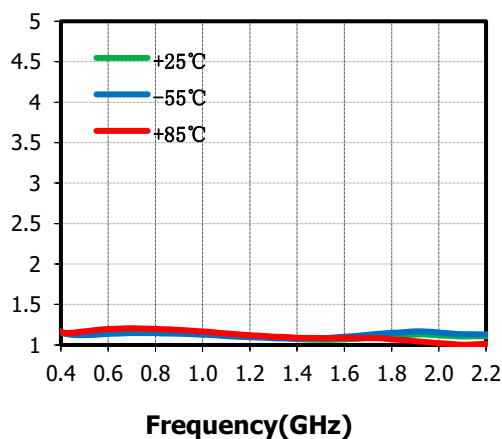
Gain(dB) vs. Temperature



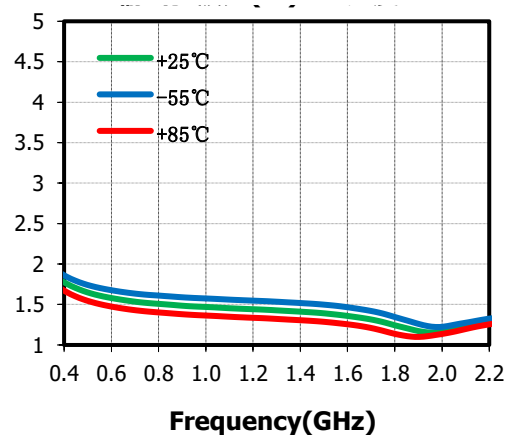
Reverse Isolation(dB) vs. Temperature



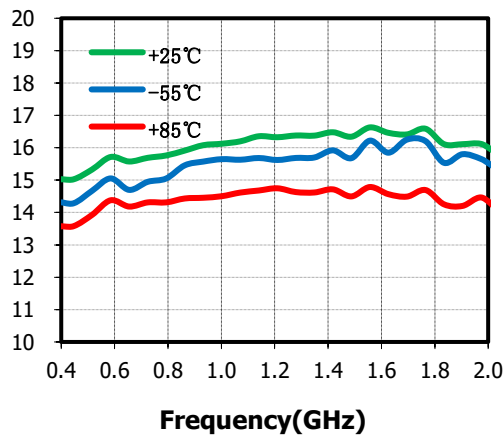
Input VSWR(:1) vs. Temperature



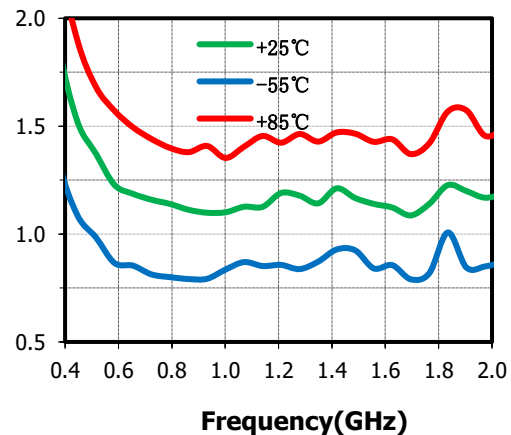
Output VSWR(:1) vs. Temperature



OP-1dB(dBm) vs. Temperature



Noise Figure(dB) vs. Temperature



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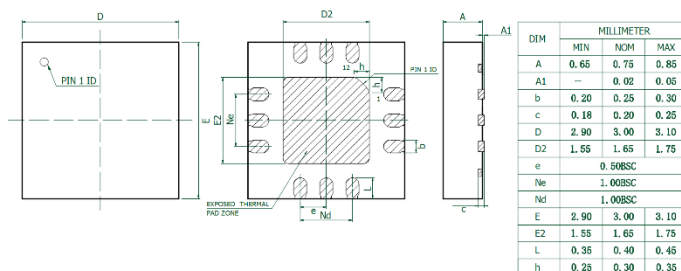
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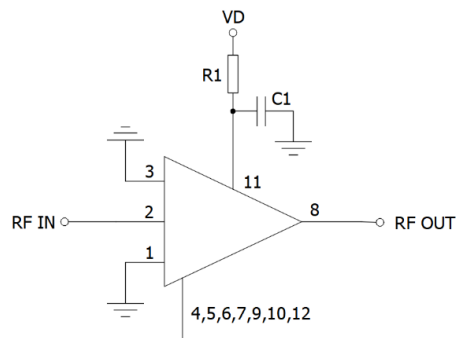
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Outline Drawing (All dimensions in mm)



Assembly Diagram



Component list

Reference Des.	Value	Part Number	Manuf.	Size
R1	15			0603
C1	10nF	GRM155R71H103KA88D	MURATA	0402

Attention:

1. The moisture resistant grade of products is 2A, the storage environment $\leq 30^{\circ} \text{C}/60\% \text{RH}$, The surrounding workshop Life is 4 weeks.
2. After un-packing, It is necessary to bake the parts for 6 hours in 125 ± 5 degree environment before soldering.